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INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(Not for submission under 37 CFR 1.99)</i>	Application Number		10522262	
	Filing Date		2003-07-18	
	First Named Inventor		Iiro Hietanen	
	Art Unit		2811	
	Examiner Name		To Be Assigned	
	Attorney Docket Number		800186US	

U.S.PATENTS						
Examiner Initial*	Cite No	Patent Number	Kind Code ¹	Issue Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear
	1	4227942		1980-10-14	Hall	
	2	4626613		1986-12-02	Wenham et al.	
	3	4984358		1991-01-15	Nelson	
	4	5468652		1995-11-21	Gee	
	5	6836020		2004-12-28	Cheng et al.	

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	1	E.M. CHOW ET AL. "Electrical Through-Wafer Interconnects and Microfabricated Cantilever Arrays Using Through-Wafer Silicon Etching," Thesis at Stanford University, August 2001, 196 pages.	<input type="checkbox"/>
	2	E.M. CHOW ET AL., "Process Compatible Polysilicon-Based Electrical Through-Wafer Interconnects in Silicon Substrates," Journal of Microelectromechanical Systems, December 2002, pp. 631-640, Vol. 11, No. 6, IEEE.	<input type="checkbox"/>
	3	C.H. CHENG ET AL., "An Efficient Electrical Addressing Method Using Through-Wafer Vias for Two-Dimensional Ultrasonic Arrays," IEEE Ultrasonics Symposium, 2000, pp. 1179-1182.	<input type="checkbox"/>
	4	C.H. CHENG ET AL., "Electrical Through-Wafer Interconnects with Sub-PicoFarad Parasitic Capacitance," IEEE Microelectromechanical Systems Conference, 2002, pp. 18-21.	<input type="checkbox"/>
	5	V. CHANDRASEKARAN ET AL., "Through-Wafer Electrical Interconnects for MEMS Sensors," Proceedings of ASME International Mechanical Engineering Congress and Exposition, November 2001, pp. 1-6.	<input type="checkbox"/>

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EXAMINER SIGNATURE

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Please see 37 CFR 1.97 and 1.98 to make the appropriate selection(s):

- That each item of information contained in the information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the information disclosure statement. See 37 CFR 1.97(e)(1).

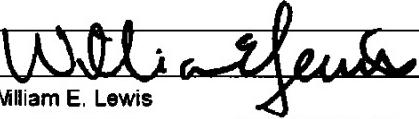
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- See attached certification statement.
 Fee set forth in 37 CFR 1.17 (p) has been submitted herewith.
 None

SIGNATURE

A signature of the applicant or representative is required in accordance with CFR 1.33, 10.18. Please see CFR 1.4(d) for the form of the signature.

Signature		Date (YYYY-MM-DD)	2006-12-04
Name/Print	William E. Lewis	Registration Number	39,274

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